



BAT54LP

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

### **Features**

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Leadless Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish NiPdAu Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208<sup>(G)</sup>
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Top View



Bottom View

# Ordering Information (Note 4)

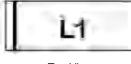
	Part Number	Case	Packaging		
	BAT54LP-7	X1-DFN1006-2	3,000/Tape & Reel		
	BAT54LP-7B	X1-DFN1006-2	10,000/Tape & Reel		
Notes:	as: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.				

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

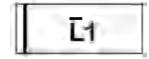
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



Top View



Top View



Bar Denotes Cathode Side

L1 or  $\overline{L}1$  = Product Type Marking Code Bar Denotes Cathode Side



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Forward Continuous Current		lF	200	mA
Repetitive Peak Forward Current		I <sub>FRM</sub>	300	mA
Forward Surge Current	@ t < 1.0s	IFSM	600	mA

# **Thermal Characteristics**

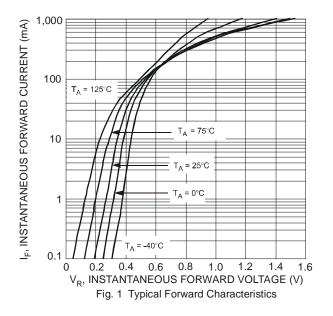
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	R <sub>0</sub> JA	400	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-65 to +125	°C

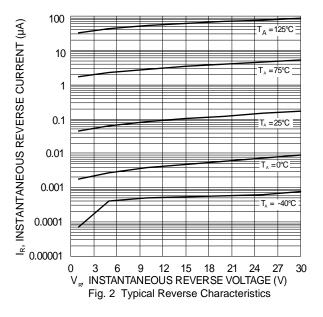
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	30	_	_	V	I <sub>R</sub> = 100μA
Forward Voltage	VF	_	_	240 320 400 500 1,000	mV	$I_{F} = 0.1mA$ $I_{F} = 1mA$ $I_{F} = 10mA$ $I_{F} = 30mA$ $I_{F} = 100mA$
Reverse Leakage Current (Note 6)	I <sub>R</sub>		_	2.0	μA	V <sub>R</sub> = 25V
Total Capacitance	CT	_	_	10	pF	V <sub>R</sub> = 1.0V, f = 1.0MHz
Reverse Recovery Time	t <sub>RR</sub>	_	_	5.0	ns	$I_F = 10mA$ through $I_R = 10mA$ to $I_R = 1.0mA$ , $R_L = 100\Omega$

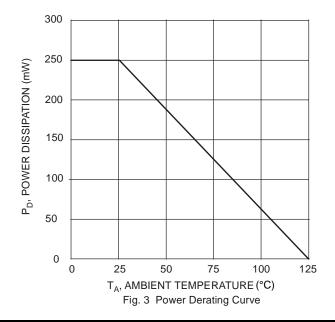
Notes:

5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html. 6. Short duration pulse test used to minimize self-heating effect.



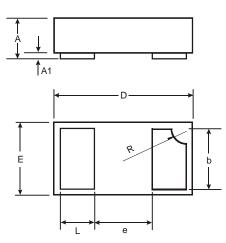






# Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



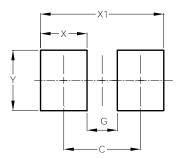
#### X1-DFN1006-2

X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.40		
∟	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1006-2



Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Y	0.70		



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